

The "SM3 Series" is a PCI-SIG PCI Express [®] M.2 Specification compatible, card edge connector into which multiple modules equipped on notebook PC and tablet PC such as Wi-Fi [®], Bluetooth [®], SSD, and others can be inserted.

PCI Express[®] is a registered trademark of PCI-SIG. Wi-Fi[®] is a registered trademark of Wi-Fi Alliance. Bluetooth[®] is a registered trademark of Bluetooth SIG.

Features

- ■Compliant with PCI Express M.2 Specification and enables transmission of PCIe Gen3, USB3.0, DisplayPort, SATA standard, and others. (Note 1)
- ■0.5mm pitch (2 row), 67 positions, compact card edge connector.
- ■Available in five types: three on-board types and two mid-mount types. Products with 4.1mm product height can mount 1mm height parts on the bottom side of the module.
- ■Board fixing method for mid-mount products is SMT type and through-hole type and either can be selected according to the board layout.
- Card edge connector into which multiple modules can be inserted and available in 4 types of polarizing keys by changing the mold.
- (Note 1) Polarizing keys are assigned according to application. For more information, please refer to PCI Express M.2 Specification.

Applicable Markets

Notebook PC, tablet PC, portable game devices, STB, and others (SSD, wireless module use)

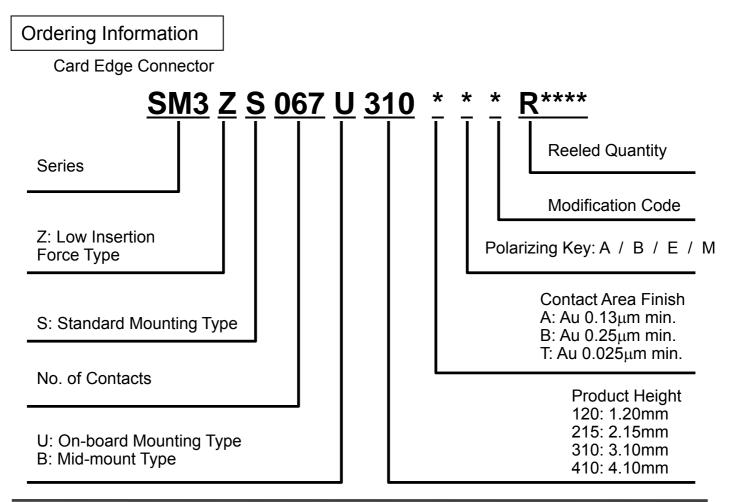
General Specifications

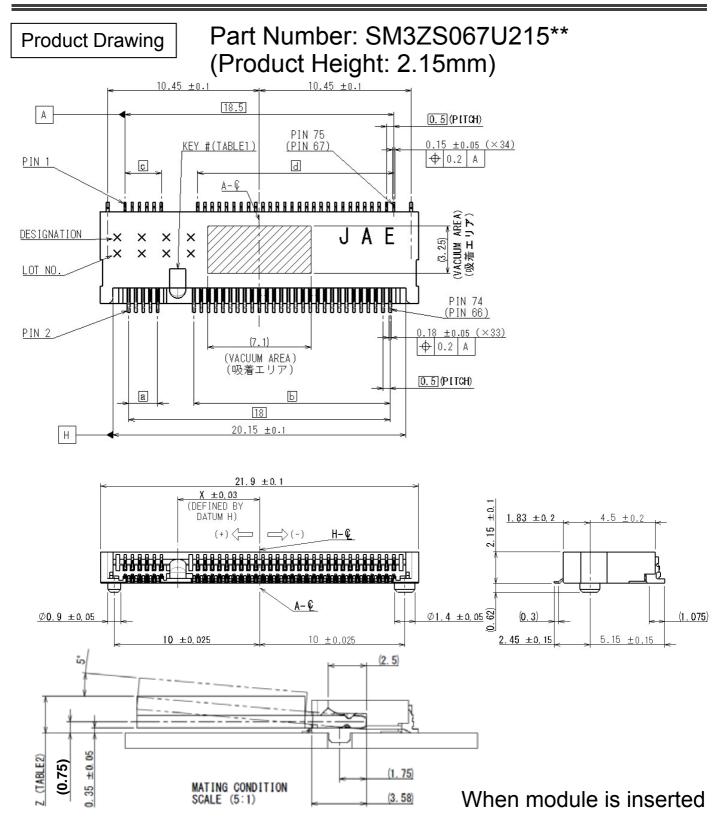
No. of Contacts: 67 positions Contact Resistance: $55m \Omega max$. Dielectric Withstanding Voltage: AC300Vr.m.s for 1 minute Operating Temperature: -40 Deg. C ~ +80 Deg. C Rated Current: 0.5A per pin Insulation Resistance: $500M\Omega$ min. (initial) Mating Cycles: 60 times

Materials and Finishes

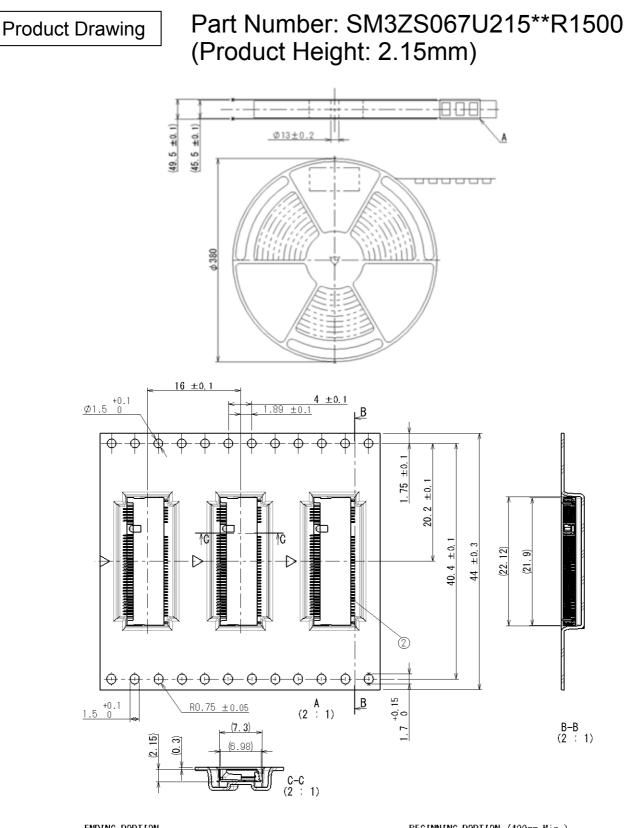
Card Edge Connector

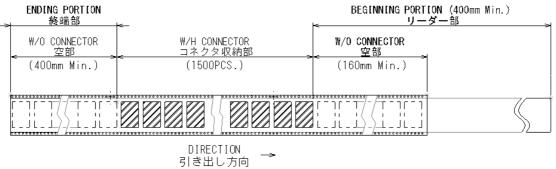
Component	Material / Finish
Hold-down	Copper alloy / Sn plating over Ni
Upper Contact	Contact area: Copper alloy / Au plating over Ni Terminal area: Copper alloy / Au flash plating over Ni
Lower Contact	Contact area: Copper alloy / Au plating over Ni Terminal area: Copper alloy / Au flash plating over Ni
Insulator	Heat resistant plastic

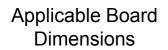




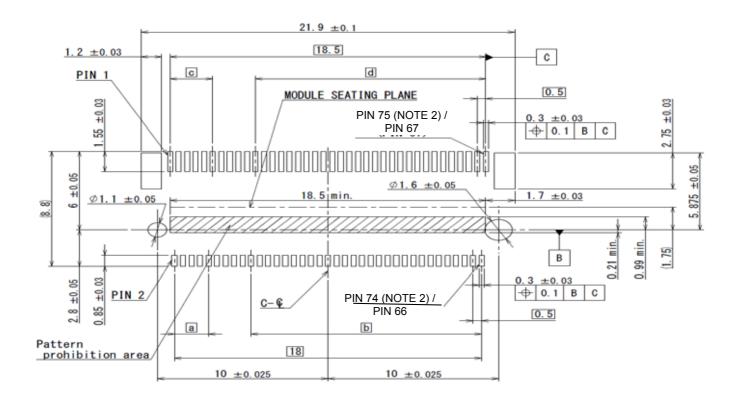
(TABLE [·]	1)	(TABLE 2)						
KEY#	X	а	b	С	d	Module	Z	
Α	+6.625	1	14.5	1.5	14.5	Height		
В	+5.625	2	13.5	2.5	13.5	MAX 1.2mm	MAX 2.45mm	
E	+2.625	5	10.5	5.5	10.5	MAX 1.35mm	MAX 2.60mm	
М	-6.125	14	1.5	14	2	MAX 1.5mm	MAX 2.75mm	



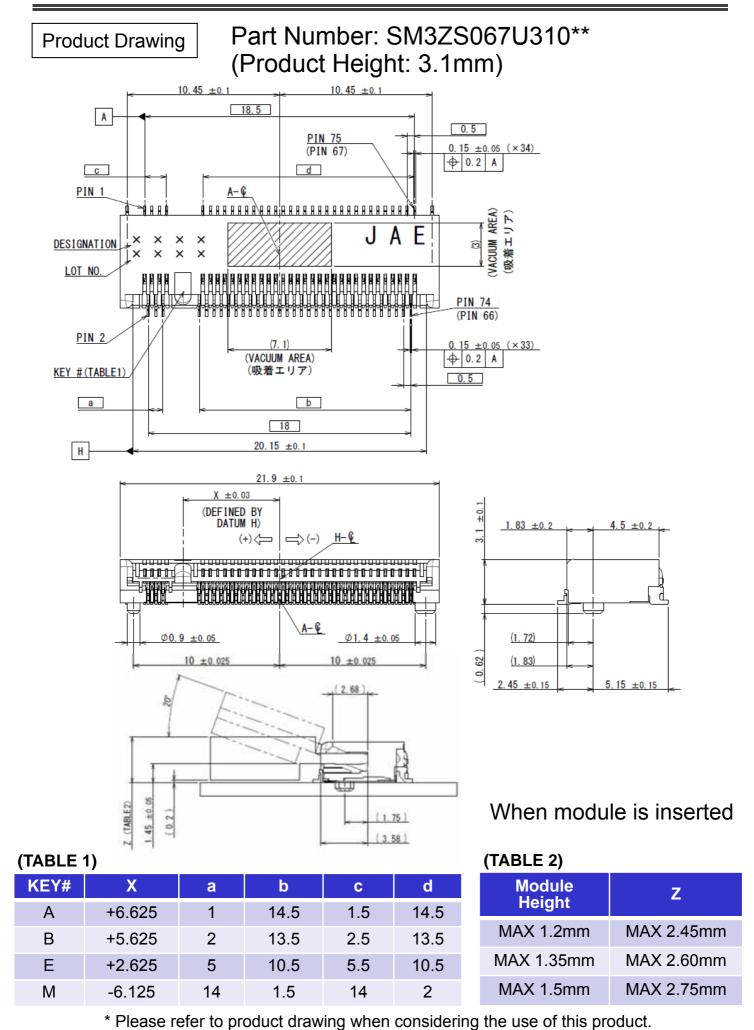


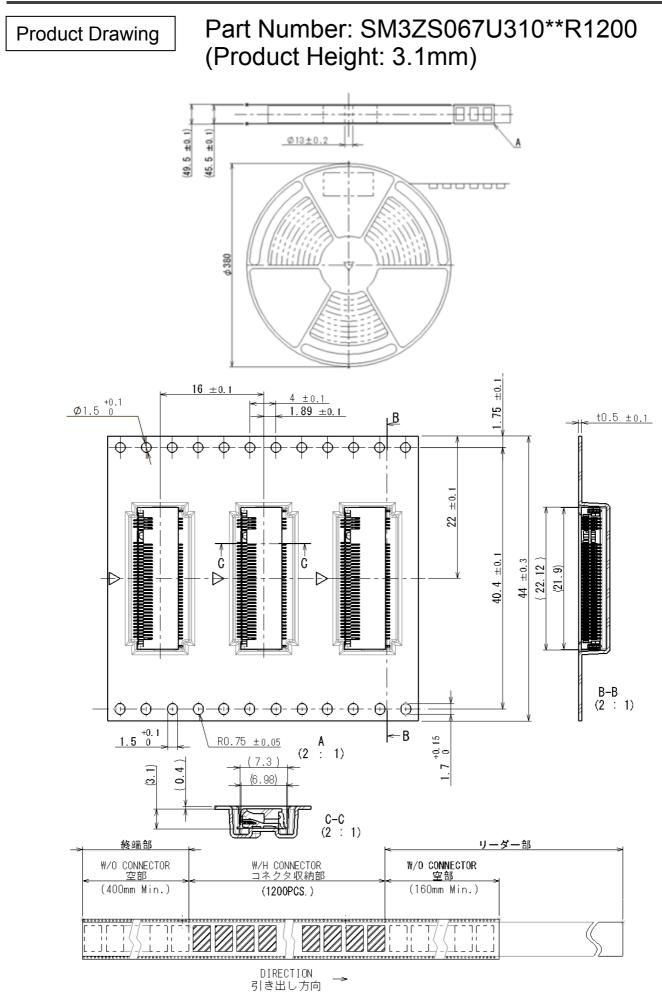


Part Number: SM3ZS067U215** (Product Height: 2.15mm)



NOTE 2: PIN NUMBER AS DEFINED BY NGFF SPECIFICATION

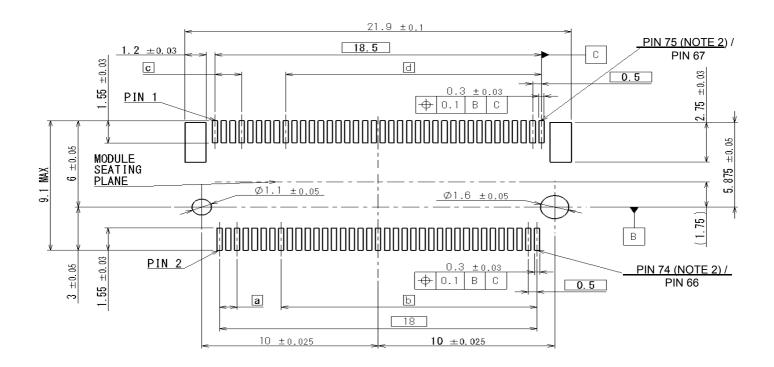




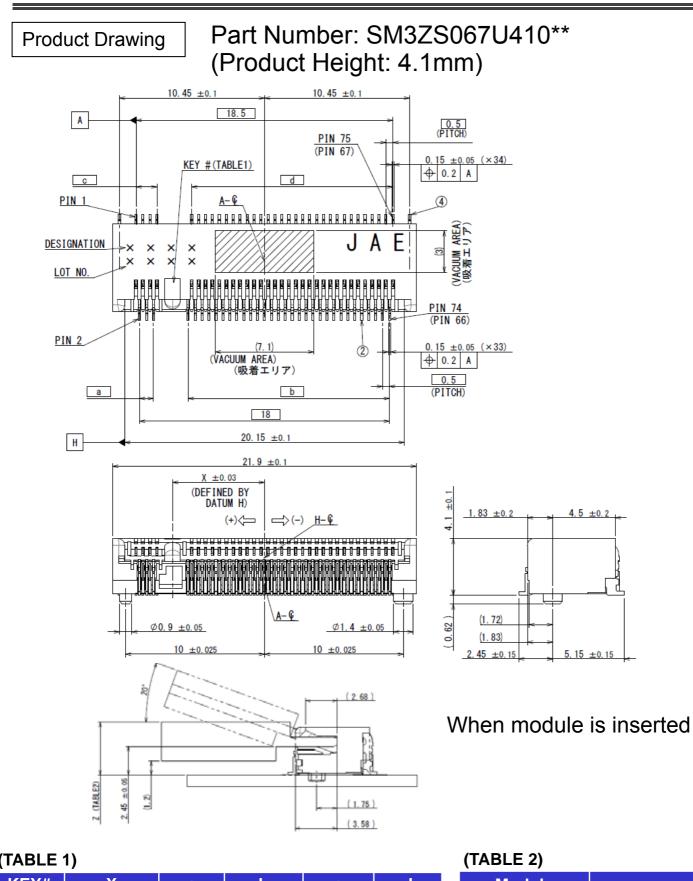
* Please refer to product drawing when considering the use of this product.

Applicable Board Dimensions

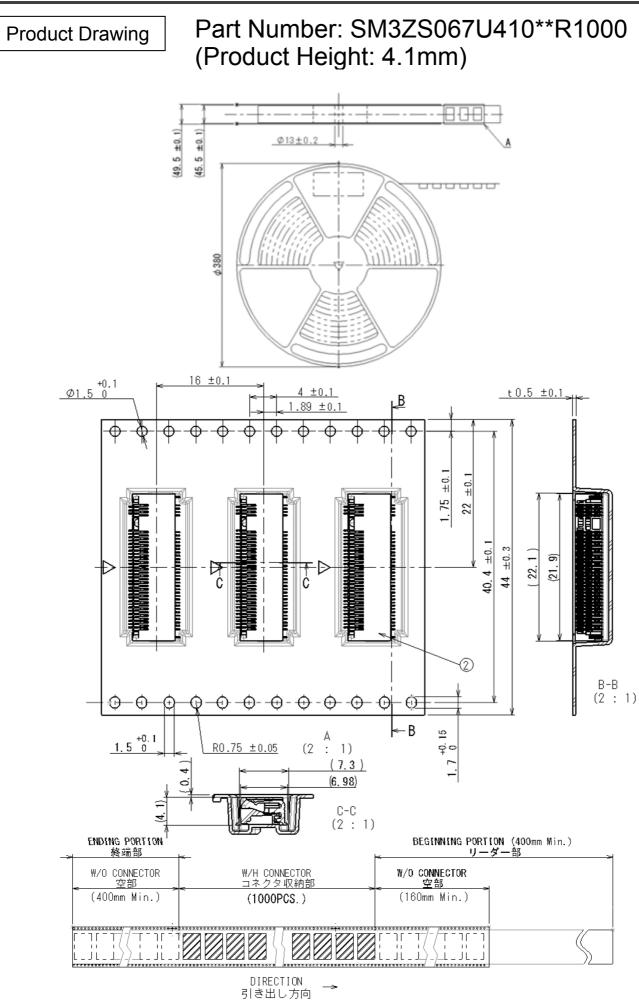
Part Number: SM3ZS067U310** (Product Height: 3.1mm)



NOTE 2: PIN NUMBER AS DEFINED BY NGFF SPECIFICATION

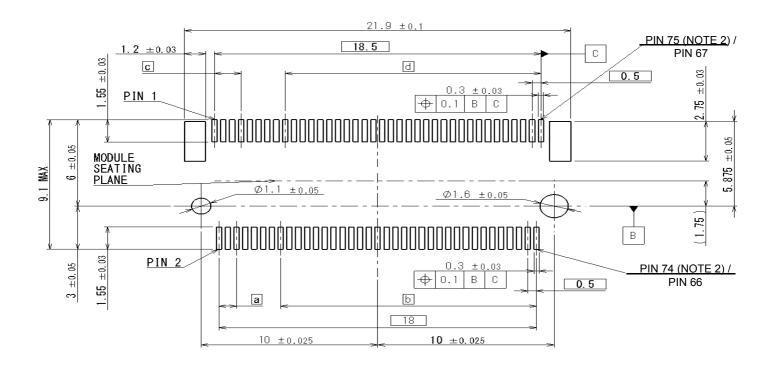


(TABLE 1) (TABLE 2)							
KEY#	X	а	b	С	d	Module	z
Α	+6.625	1	14.5	1.5	14.5	Height	
В	+5.625	2	13.5	2.5	13.5	MAX 1.2mm	MAX 2.45mm
E	+2.625	5	10.5	5.5	10.5	MAX 1.35mm	MAX 2.60mm
М	-6.125	14	1.5	14	2	MAX 1.5mm	MAX 2.75mm

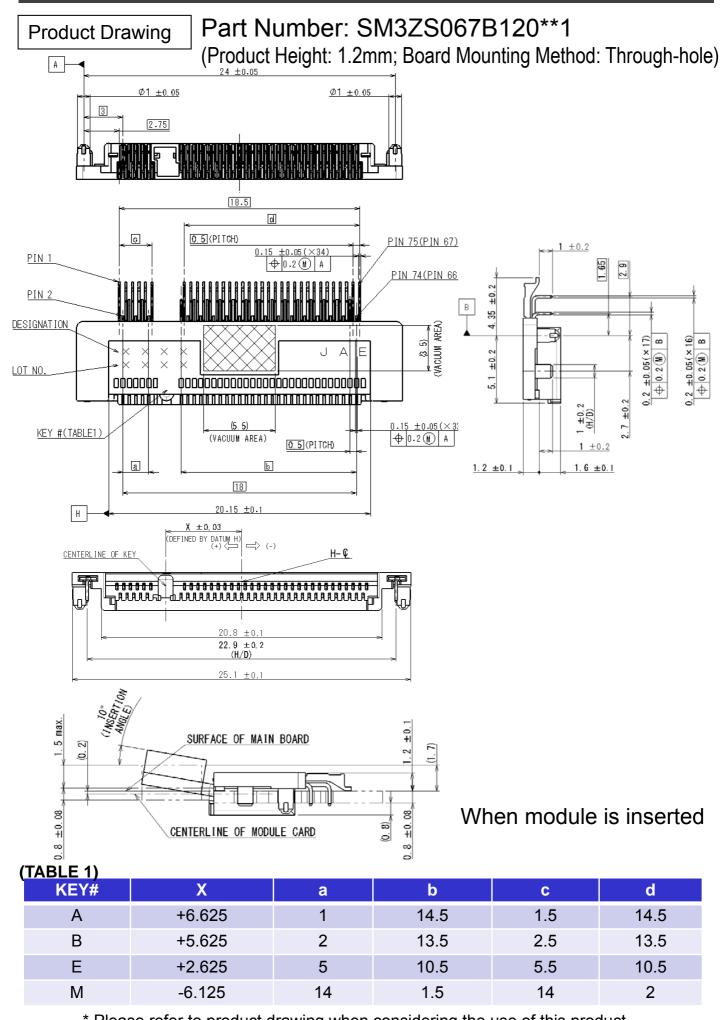


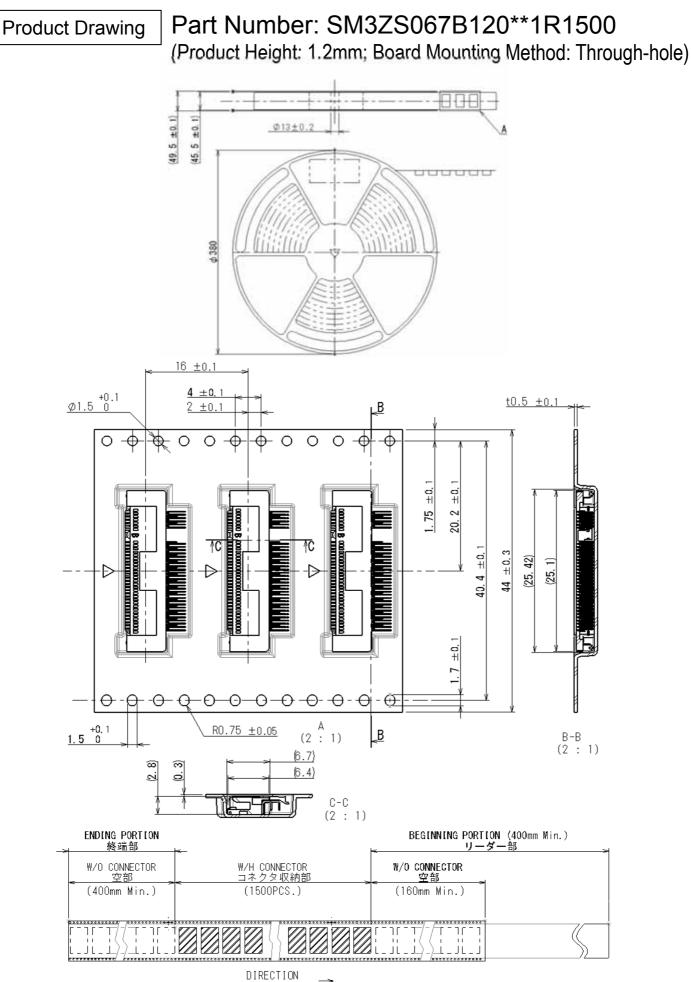
Applicable Board Dimensions

Part Number: SM3ZS067U410** (Product Height: 4.1mm)

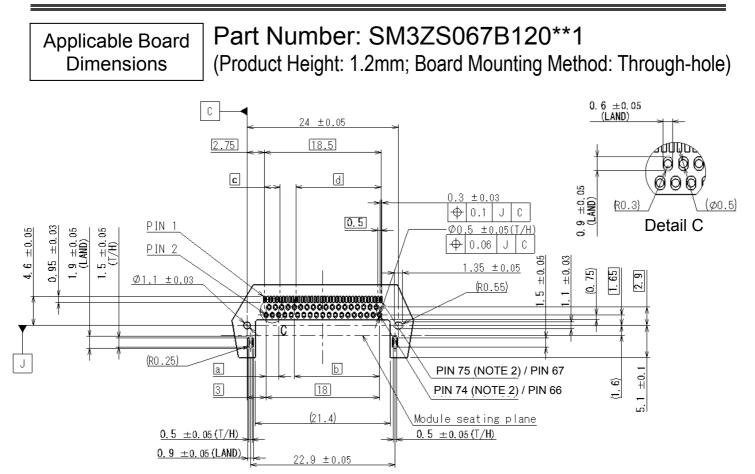


NOTE 2: PIN NUMBER AS DEFINED BY NGFF SPECIFICATION

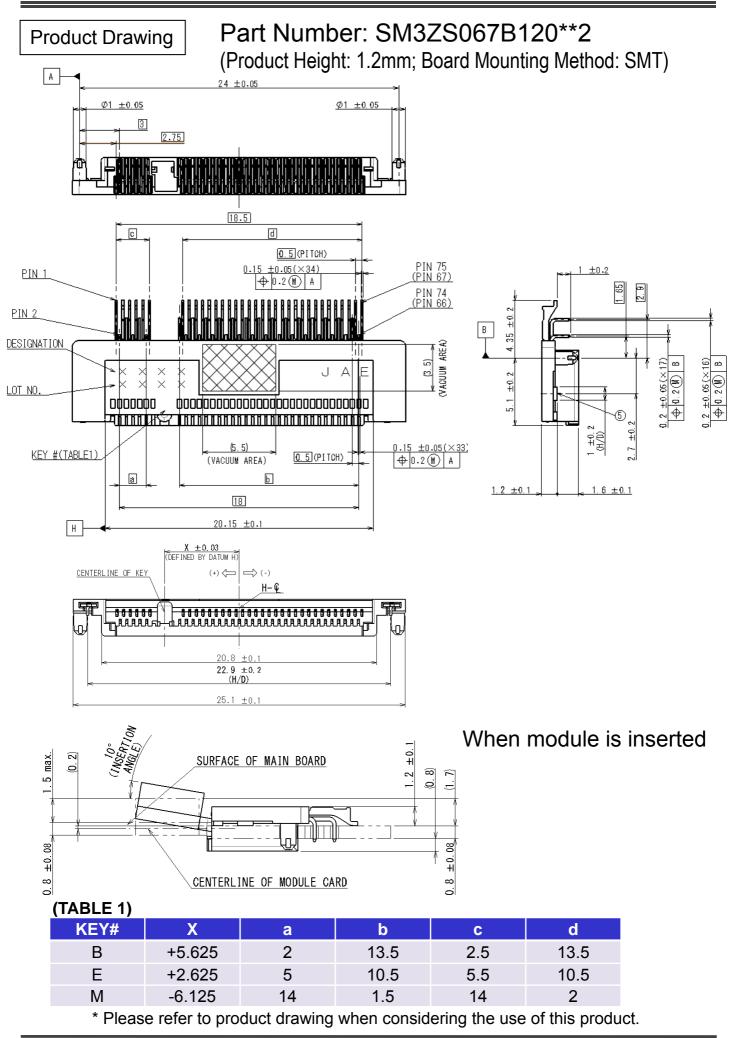




引き出し方向 →



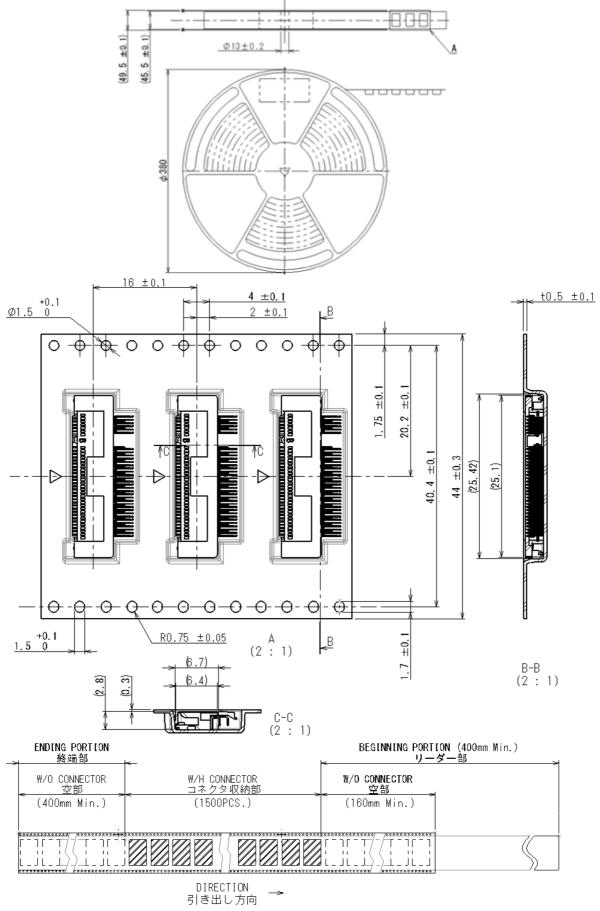
NOTE 2: PIN NUMBER AS DEFINED BY NGFF SPECIFICATION

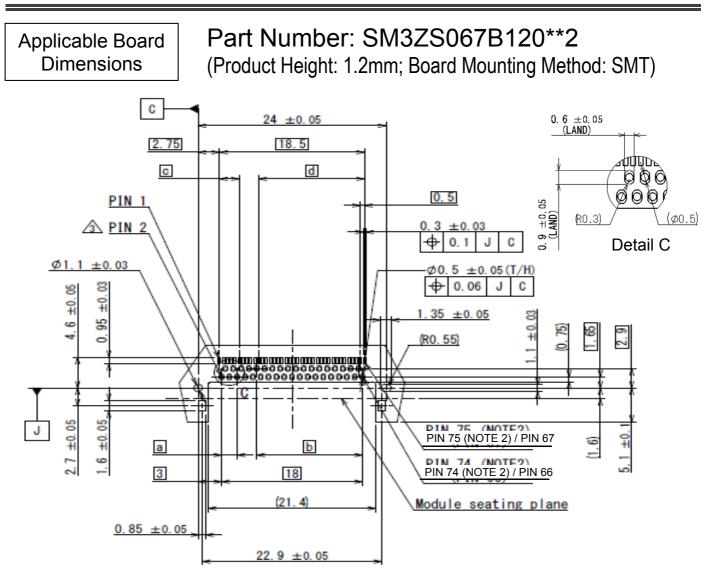


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Product Drawing

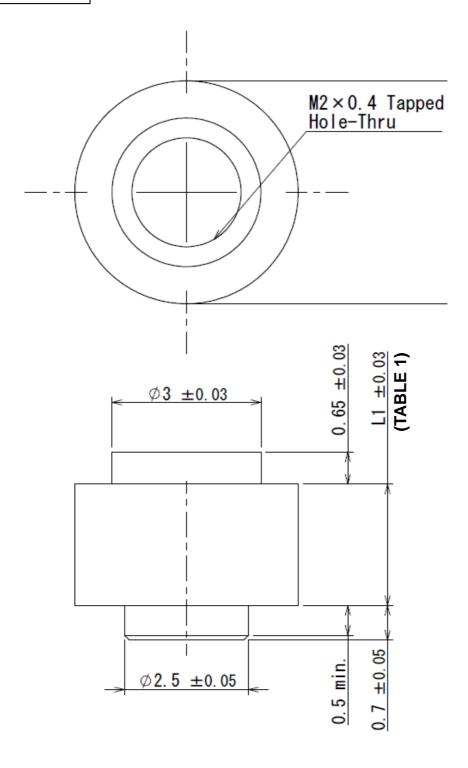
Part Number: SM3ZS067B120**2R1500 (Product Height: 1.2mm; Board Mounting Method: SMT)





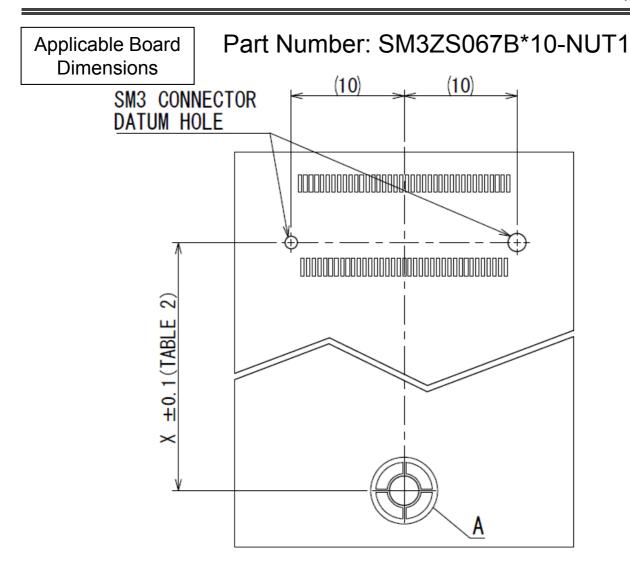
NOTE 2: PIN NUMBER AS DEFINED BY NGFF SPECIFICATION

g Part Number: SM3ZS067B*10-NUT1



(TABLE 1)

Part Number	L1	Drawing Number	Embossed Package Product	Drawing Number	Compatible Connector
SM3ZS067U310-NUT1	1.45	SJ116266	SM3ZS067U310- NUT1-R1800	SJ116261	SM3ZS067U310** (DWG.NO.SJ113505)
SM3ZS067U410-NUT1	2.45	3110200	SM3ZS067U410- NUT1-R1200	SJ116260	SM3ZS067U410** (DWG.NO.SJ113503)



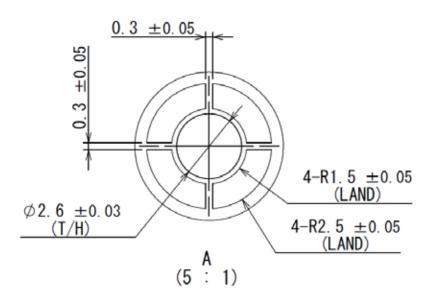
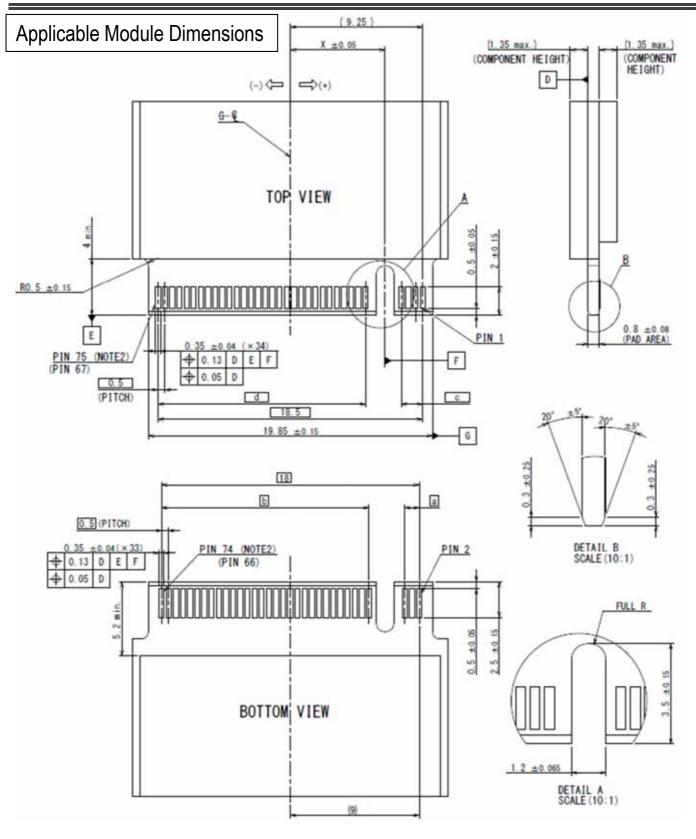


TABLE 2

Module Card Length	Х		
16	14. 25		
26	24. 25		
30	28. 25		
42	40. 25		
60	58. 25		
80	78. 25		
110	108. 25		



(TABLE 1)

KEY#	Х	а	b	С	d
А	+6.625	1	14.5	1.5	14.5
В	+5.625	2	13.5	2.5	13.5
E	+2.625	5	10.5	5.5	10.5
М	-6.125	14	1.5	14	2

		•						
Part Number		SM3ZS067 U215** (R1500)	SM3ZS067 U310** (R1200)	SM3ZS067 U410** (R1000)	SM3ZS067 B120**2 (R1500)	SM3ZS067 B120**1 (R1500)	SM3ZS067 U310-NUT1 (R1800)	SM3ZS067 U410-NUT1 (R1200)
Mounting Ty	ре		On-board		Mid-	mount		
Depth [mm]		(7.6)	(7.6)	(7.6)	(9.45)		-	-
Height [mm]		2.15+/-0.1	3.1+/-0.1	4.1+/-0.1		+/-0.1 t when mounted)	1.45+/-0.03	2.45+/-0.03
Width [mm]		21.9	21.9	21.9	2	25.1	Φ	4.5
	Developed	A/B/E/M	A/B/E/M	A/B/E/M	B/E/M	A/B/E/M		
Polarizing Key	Development under consideration				A			
Contact	0.13µm	√	✓	√		√		
Area Au Plating	0.25µm		✓	✓				
thickness	0.025µm	√	✓	√				
Board Fixing	Method		SN	ſΤ		Through-hole	SI	ΛT
Evaluation Test		SR-C-1317 (0.13µm, 0.25µm Product)	SR-C-1225 (0.13µm, 0.25µm Product)	SR-C-1249 (0.13µm, 0.25µm Product)	SR-C-1322			
	Col	SR-C-1555 (0.025µm Product)	SR-C-1556 (0.025µm Product)	SR-C-1557 (0.0.25µm Product)	- SR-0-1322			
Specifications		JACS-10937	JACS-10941 (0.13µm, 0.25µm Product)	JACS-10941 (0.13µm, 0.25µm Product)	- JACS-11000 JACS-110		11008	
			JACS-11171 (0.025µm Product)	JACS-11171 (0.0.25µm Product)			JAC2-11090	
Drawing No.	Individual	SJ113567 (0.13µm,025µm Product)	SJ113505 (0.13µm,025µmProduct)	SJ113503 (0.13µm,025µm Product)	SJ114364 SJ114362		SJ116266	
	Product	SJ117622 (0.0.25µm Product)	SJ117624 (0.025µm Product)	SJ117626 (0.0.25µm Product)				
	o. Packaged Product	SJ113568 (0.13µm,025µmProduct)	SJ113506 (0.13µm,025µmProduct)	SJ113504 (0.13j.m, 0.25j.m Product)	- SJ114365	SJ114363	SJ116261	0 1110000
		SJ117623 (0025µm Product)	SJ117625 (0.025µm Product)	SJ117627 (0.0.25µm Product)				SJ116260

Product Drawing and Specification Numbers

Notice:

1. The values specified in this brochure are only for reference. The products and their specifications are subject to change without notice. Contact our sales staff for further information before considering or ordering any of our products.

For purchase, a product specification must be agreed upon.

2. Users are requested to provide protection circuits and redundancy circuits to ensure safety of the equipment, and sufficiently review the suitability of JAE's products to the equipment.

3. The products presented in this brochure are designed for the uses recommended below.

We strongly suggest you contact our sales staff when considering use of any of the products in any other way than the recommended applications or for a specific use that requires an extremely high reliability.

(1) Applications that require consultation:

(i) Please contact us if you are considering use involving a quality assurance program that you specify or that is peculiar to the industry, such as:

Automotive electrical components, train control, telecommunications devices (mainline), traffic light control, electric power, combustion control, fire prevention or security systems, disaster prevention equipment, etc.

(ii) We may separately give you our support with a quality assurance program that

you specify, when you think of a use such as :

Aviation or space equipment, submarine repeaters, nuclear power control systems, medical equipment for life support, etc.

(2) Recommended applications include:

Computers, office appliances, telecommunications devices (terminals, mobile units), measuring equipment, audiovisual equipment, home electric appliances, factory automation equipment, etc.

Japan Aviation Electronics Industry, Limited

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